

DECLARATION AND POWER OF ATTORNEY U.S.A.

FOR ATTORNEYS' USE ONLY	
ATTORNEYS' DOCKET NO.	

	As a below name original, first and	d inventor, I declare sole inventor (if only	that my resid y one name is	ence, post office address and listed at 201 below), or an or	d citizenshi riginal, first	ip are stated below next to my nam and joint inventor (if plural invento	ne, the informat ors are named I	on given lelow at 2	nerei 01-2	in is true, tha 03, or on add	t I believe that I fitional sheets a	am the
101	hereto) of the sub	hereto) of the subject matter which is claimed and for which patent is sought on the invention entitled: "Methods of Detecting Immune Response"										
which is described and claimed in: PCT International Application No. filed												
_	which is describe	d and claimed in:		emational Application No.	_	×	f	led				
	the attached	specification	the spe	ecification in application Seria	al No.		fi	led $\underline{1}$	4,	Jan.	2004	
			, (if app	licable) and amended on	_	G					•	
	I acknowledge the I hereby claim for	e duty to disclose in eign priority benefits ation for patent or in	formation whic under Title 35	h is material to patentability a 5, United States Code, §119	as defined i (a)-(d) of a	scification, including the claims, as a in Title 37, Code of Federal Regula ny foreign application(s) for patent the application on which priority is c	itions, §1.56. ~ or inventor's ce	rtificate lis	ted I			d below
					<u> </u>		- [_					
	(Number)		(Co	untry)		(Day/Month/Year Filed)	Yes	¬ ·			No	
_							_ [_	J				
	(Number)		(Co	(Country)		(Day/Month/Year Filed)	Yes	_			No	
103							. L	_				
	(Number)		(Co	ountry)		(Day/Month/Year Filed)	Yes				No	
105 104	Application No Filing Date I hereby claim the benefit under Title 35, United States Code, §120 of any United States application in the manner provided by					Application No pplication(s) listed below and, insofa graph of Title 35, United States Co	ar as the subje	e subject matter of each of the claims of this application is 2, I acknowledge the duty to disclose information which is				
	(An	plication Serial No.)	(Filing D	rate)	(Status:	patented.	pen	ding, abando	ned)			
my a	NER OF ATTORNE agent, and transact RKE HOLMAN (22,	Y: As a named in all business in the 769); MARVIN R	ventor, I her e Patent and . STERN (20	Trademark Office conne 0,640); ALLEN S. MELSE	attorney ected the ER (27,21	s (Registration No.) to prosec rewith. HARVEY B. JACOBS 5); MICHAEL R. SLOBASKY THANIEL A. HUMPHRIES (22	cute this appl SON, JR. (20, (26,421); JO	ication, r 851); D.	ece	ive and act UGLAS PR	on instruction ICE (24,514);	HOL;
or	D CORRESPONDE		OMER NO. 0	0136		DIRECT TELEPHONE CALL (please use Attorney's Dock		9) 638-66	66			
1	JACOBSON HOLMAN PROFESSIONAL LIMITED LIABILITY COMPANY 400 SEVENTH STREET, N.W. WASHINGTON, D.C. 20004					JACOBSON HOLMAN PROFESSIONAL LIMITED LIABILITY COMPANY						
*Inv	entor(s) name must	include at least o	ne unabbrev	iated first or middle name	e.							
	FULL NAME	FAMILY NAMI	E		GIVEN NAME			MIDDLE NAME				
l	OF INVENTOR*	LO							n.a.			
٦	RESIDENCE &	CITY				OR FOREIGN COUNTRY				F CITIZEN	SHIP	
10	CITIZENSHIP	Hung Hom. K	owloon		I Hong	Kong SAR, China	I H	Hong Kong SAR, China				

201	FULL NAME	FAMILY NAME	GIVEN NAME	MIDDLE NAME				
	OF INVENTOR*	LO	Samuel Chun-Lap	n.a.				
	RESIDENCE &	CITY	STATE OR FOREIGN COUNTRY	COUNTRY OF CITIZENSHIP				
	CITIZENSHIP	Hung Hom, Kowloon	Hong Kong SAR, China	Hong Kong SAR, China				
1`		POST OFFICE ADDRESS	CITY	TATE OR COUNTRY ZIP CODE				
	POST OFFICE ADDRESS	c/o Applied Biology and Chemical Technology The Hong Kong Polytechnic University	Hung Hom, Kowloon	Hong Kong SAR, China n.a.				
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ı	OF INVENTOR*	WONG	Man-Sau	n.a.				
١.	RESIDENCE & CITIZENSHIP	CITY	STATE OR FOREIGN COUNTRY	COUNTRY OF CITIZENSHIP				
18		Hung Hom, Kowloon	Hong Kong SAR, China	Hong Kong SAR, China				
Ι,	POST OFFICE ADDRESS	POST OFFICE ADDRESS .	CITY	STATE OR COUNTRY ZIP CODE				
		c/o Applied Biology and Chemical Technology The Hong Kong Polytechnic University	Hung Hom, Kowloon	Hong Kong SAR, China n.a.				
Г	FULL NAME	FAMILY NAME	GIVEN NAME	MIDDLE NAME				
1	OF INVENTOR*	WANG	Adam Yuen-Yuen	n.a.				
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I further declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment or both, under section 1001 of Title 18 of the United States Code; and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

SIGNATURE OF INVENTOR 201*	SIGNATURE OF INVENTOR/202*	SIGNATURE OF INVENTOR 203*
-56	Worland	19 maggiorgien
DATE 2 1 Jan 2004	DATE /2/1/04	DATE 30.01. 2004

Additional inventors are named on separately numbered sheets attached hereto.



Law Offices of

JACOBSON HOLMAN
PROFESSIONAL LIMITED LIABILITY COMPANY
THE JENIFER BUILDING 400 SEVENTH STREET, N.W. WASHINGTON, DC 20004

Attny's Docket No.	

SMALL ENTITY DECLARATION [37 CFR 1.9(c-f)]

Each undersig	gned declar	es that:	•							
(1)	the	e application attache	d hereto.							
(2)	X U.:	S. Application Serial	No.	<u></u>	, filed	14	Jan,	2004	Ç	
(3)	U.:	S. Patent No.		Issued						_
is entitled to the form		of "small entity" stat	us for paying reduced	fees under 35	USC 41	(a) and	(b) to the	e Patent an	d Trade	mark Office by
(4) as defined in			clares that he/she qual	lifies as an ind	lepender	nt invent	or, or we	ould qualify	had he	s/she made the
(5) concern qualit remain with th 1.9.	fies as a sm	all business concer	ares that he/she is an n as defined in 37 CFR the rights are not exc	R 1.9(d); that ex	kclusive i	rights to	the inve	ntion have l	been co	inveyed to and
6) organization o		e undersigned deck a nonprofit organiza	ares that he/she is an tion as defined in	official empow	ered to	act on b	ehalf of	the organiz	ation ic	lentified below:
	(a)	X 37 CFR 1.9(e)(1)							
	(b)	37 CFR 1.9(e)(2)							
	(c)	37 CFR 1.9(e)(3)							
)(4) State law ion have been conveye nizations as defined in	ed to and rema	ain with	the orga	ınization	, or if the rig	ghts are	: not exclusive,
(7) under contrac			organization to which				l, conve	yed or licer	nsed, o	r am under an
	(a)	no such perso	on, concern or organiza	ation						
			cerns or organization lis d from <u>each</u> named pe		or orga	nization	having	rights to thi	s inven	tion averring to
Full Name		Kong Polytechnic	University							
Address	Hung Hor	n, Kowloon, Hong	Kong SAR, China			_				
	_	dividual	Small Busines					t Organizati		
entity prior to	paying, or a	e duty to file, in this at the time of paying appropriate. (37 CFF	application or patent, n g, the earliest of the iss t 1.28(b))	notification of a sue fee or any	ny chang mainten	ge in sta nance fe	tus resu e due at	Iting in loss fter the date	of entite on wh	lement of small iich status as a
belief are beli punishable by	ieved to be fine or imp	true; and further th	e herein of his/her ow at these statements w under Section 1001 of any patent issued ther	ere made with Title 18 of the	the kno United	owledge States C	that will ode and	ful false sta I that such v	atement willful fa	s so made are
(8) <u>Samu</u>	el Chun-Lap LO)			<u> </u>	12004
	Man-S	Typed Name of Sau WONG	Inventor	Signature	Mad	0			Date /	12004
		Typed Name of		Signature		Pl.	,		Date	01.2004
	Adam	Yuen-Yuen WANG Typed Name of		Signature		ana	<u>~~</u>	. -	Date	01.009
(9	The H	Typed Name of long Kong Polytecl		Signature					Date	
ζ-	•		Name of Small Bu	usiness Conce	rn or No	nprofit C	rganizat		0.2	2004
	Typed	<u>IUI Sun-win</u> Name e President	g ^{By} . Partnership	Signature Develop	ment	Hi	H	× ′-	Date	
©.	Title o	f Signatory	ying without deletions	•	III II					